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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re Patent Application of:

TSUNEMASU et al.

Serial No.: 09/872,256

Filed: 6/1/01

For: MOUNTING STRUCTURE OF SEMICONDUCTOR PACKAGE

Our Ref.: P/2041-61

Date: December 4, 2001

Group Art Unit: 2833

Examiner: --

Assistant Commissioner of Patents
Washington, D.C. 20231

SUBMISSION OF SUBSTITUTE DECLARATION

Sir:

Applicants submit herewith a substitute Declaration which corrects the filing date of the Japanese priority application.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first-class mail in an envelope addressed to:
Assistant Commissioner for Patents, Washington,
D.C. 20231-9999, on December 4, 2001:

Steven I. Weisburd

Name of applicant, assignee or
Registered Representative

Signature

December 4, 2001

Date of Signature

Respectfully submitted,

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